

IrDA 115.2kbps Transceiver

PRELIMINARY

FEATURES

- Supports IrDA Standard to 115kbps **Data Rates**
- 3V to 5V Operation
- Wide Dynamic Receiver Range from 200nA to 50mA Typical
- IrDA Compliant I/O
- 500mA LED Driver
- Very Low Quiescent Current in Active Mode (250µA Typical)
- Ultra Low Quiescent Current in Sleep Mode (0.5µA Typical)
- Compatible with IrDA Detector Diodes

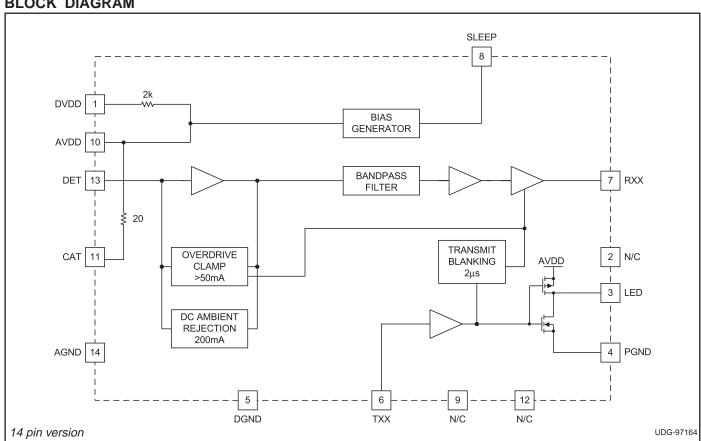
DESCRIPTION

The UCC5342 IrDA (Infrared Data Association) Transceiver supports the analog section of the IrDA standard. The receiver has a limiting transresistance amplifier to detect a current signal from a PIN diode and drives RXX pulses to a UART. The amplifier is capable of input currents ranging from 200nA to 50mA. The amplifier is bandpass limited to reduce interference from other IR sources.

The output of the receiver is designed to drive CMOS and TTL levels, for direct interfacing to IrDA compliant UARTs and Super I/O devices. Internal resistors are provided for decoupling the detector diode supply, thus minimizing the number of external components required.

The transmitter portion of the chip has a low impedance open drain MOSFET output. It is capable of sinking 300mA from an output LED at 3V, and 500mA at 5V.

BLOCK DIAGRAM

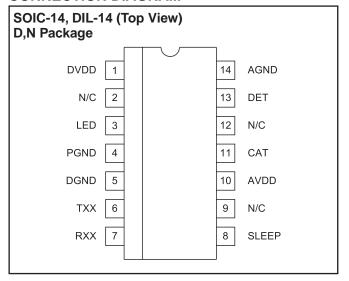


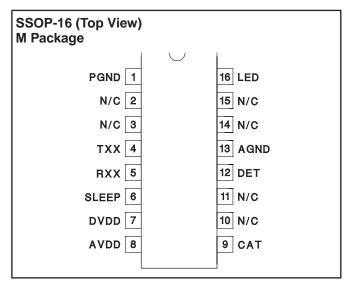
ABSOLUTE MAXIMUM RATINGS

AVDD, DVDD, CAT0.3V to 7V
SLEEP, DET, TXX, LED,
DVDD, CAT
IRXX
IDET
ILED
Storage Temperature65°C to +150°C
Junction Temperature55°C to +150°C
Lead Temperature (Soldering, 10sec.) +300°C

All voltages are with respect to respect to AGND. DGND and PGND must be connected to AGND. Currents are positive into, negative out of the specified terminal. Consult Packaging Section of the Databook for thermal limitations and considerations of packages.

CONNECTION DIAGRAM





ELECTRICAL CHARACTERISTICS: Unless otherwise specified, TA = 0°C to 70°C, AVDD = 3.0V to 5.5V, CAVDD = 100nF, CDVDD = 100nF, CCAT = 4.7μ F + 100nF, CRXX = 40pF, CDET < 56pF. TA = TJ.

PARAMETER	TEST CONDITION	MIN	TYP	MAX	UNITS			
Supply Current Section								
IDD	No Output Load, SLEEP ≤ 0.5V		250	350	μΑ			
IDD	$SLEEP \ge AVDD - 0.5V, TXX \le 0.5V$		0.5	3	μΑ			
Rovdd	AVDD to DVDD	1.0	2	3.0	kΩ			
RCAT	AVDD to CAT	10	20	32	Ω			
Receiver Section								
Input Refered Noise	(Note 1)		10		$\frac{pA}{\sqrt{Hz}}$			
Detection Threshold	1.6µs Input Pulse, 1µs ≤ Rxx ≤ 8µs		200	400	nA			
Signal to Noise Ratio	IDET = 200nA (Note 1)		11.8					
Lower Band Limit	(Note 1)		50		kHz			
Upper Band Limit	(Note 1)		1		MHz			
Output Pulse Width	IDET = 400nApk to 20mApk, 0 to 200μADC, 1.6μs Input Pulse	1.0		8.0	μs			
RXX Output (VoL)	$IRXX = 800\mu A$		200	400	mV			
RXX Output (VOH)	$IRXX = -100\mu A$, $DVDD - RXX$		200	400	mV			
RXX Rise Time	From 10% to 90% of DVDD		150	200	ns			
RXX Fall Time	From 90% to 10% of DVDD		100	150	ns			

ELECTRICAL CHARACTERISTICS (cont.): Unless otherwise specified, TA = 0°C to 70°C, AVDD = 3.0V to 5.5V, CAVDD = 100nF, CDVDD = 100nF, CCAT = 4.7μ F + 100nF, CRXX = 40pF, CDET < 56pF. TA = TJ.

PARAMETER	TEST CONDITION	MIN	TYP	MAX	UNITS				
Transmitter Section									
ITXX	TXX = 0 to AVDD	-10		10	μΑ				
TXX (VIH)			2	2.5	V				
TXX (VIL)		0.8	1		V				
LED	TXX = AVDD = 4.5V, $ILED = 500mA$		0.3	0.6	V				
	TXX = AVDD = 3.0V, $ILED = 300mA$		0.3	0.6	V				
AVDD – LED	TXX = 0, $AVDD = 3.0V$, $ILED = -1mA$		0.2	0.6	V				

Note 1: Guaranteed by design. Not 100% tested in production.

PIN DESCRIPTIONS

AGND: Ground reference for analog circuits. Connect to circuit board ground plane.

AVDD: Supply pin for analog circuits. Bypass to AGND with a 100nF or $1\mu F$ ceramic capacitor.

CAT: Filtered supply for PIN diode cathode. Internally connected to AVDD with a 20Ω resistor. Bypass to AGND with a $4.7\mu\text{F}$ capacitor plus a 100nF ceramic capacitor.

DET: Input to receiver amplifier. Connect to PIN diode anode. Shield with a AVDD and/or AGND from all other signals, especially RXX.

DGND: Ground pin for digital circuits. Connect to circuit board ground plane.

DVDD: Supply pin for digital circuits. Internally connected

APPLICATION INFORMATION

Ground Plane

There are 3 ground connections shown on the application drawing, representing the sensitive analog ground, the 'dirty' digital ground and the high current transmitter ground. These 3 points can simply be geographic groupings of connections to a ground plane. If a ground plane is not used, other provision to isolate the analog and digital ground currents should be provided. The use of a ground plane is strongly recommended.

DET Considerations

DET is flanked by AGND and an unconnected pin. This should be used to good advantage by fully enclosing the DET circuit board trace with AGND in order to shield leakage noise from DET. The DET circuit board trace length should be minimized. Since the PIN diode connected to DET is capacitive, noise coupling to the cathode of the diode will be coupled directly to DET. For this reason, the 100nF capacitor on CAT should be located physically close to the cathode of the PIN diode.

to AVDD with a $2k\Omega$ resistor. Bypass to DGND with a 100nF or $1\mu F$ ceramic capacitor.

LED: Open drain of transmitter output transistor. Connect to an external IrDA compliant light emitting diode via an external resistor.

PGND: Source of transmitter output transistor. Connect to circuit board ground plane.

RXX: Output of the detect amplifier and buffer. Connect to UART. Avoid coupling the RXX signal to DET.

SLEEP: Sleep mode select pin. A logic high on SLEEP puts the chip into sleep mode, reducing IDD to $0.5\mu A$ typical.

TXX: Input from UART to transmit LED driver.

There is natural parasitic coupling from RXX to DET. RXX should be routed to minimize the parasitic capacitive coupling from RXX to DET.

Analog Power Supply Decoupling

The UCC3542 has a highly sensitive amplifier section capable of detecting extremely low current levels (200nA typical). Achieving this sensitivity requires quiet analog power supply rails. A 100nF high frequency capacitor in close proximity to AVDD and AGND is required for quiet analog rails.

The transmitter section of the chip runs form the AVDD supply and draws high peak currents (~500mA in a typical application). A bulk capacitor may be required close to the AVDD and AGND pins if the connection length to the power supply is long, or if the supply is relatively high impedance. This bulk capacitor is in addition to the 100nF high frequency capacitor mentioned above. The bypass capacitors on CAT and AVDD should present very low equivalent series resistance and inductance to the circuit.

APPLICATION INFORMATION (cont.)

Digital Power Supply

DVDD is fed directly from AVDD through an internal 2k resistor. The DVDD bypass capacitor handles all transient current produced by the digital section of the chip. If more drive is required from RXX, than the internal 2k resistor will allow, an external resistor can shunt it. This technique should always be accompanied by increasing

the value of the decoupling capacitor on DVDD and AVDD.

Economy Application

The diagram of the economy application shows only one bypass capacitor. This application is suitable where maximum sensitivity is not required and where the power supply feeding AVDD is relatively clean and low impedance.

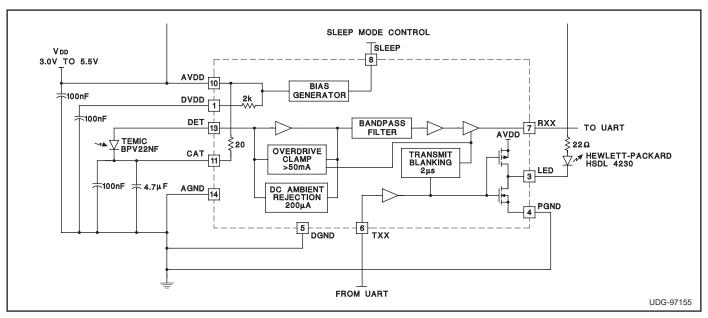


Figure 1. Typical Application of the UCC5342

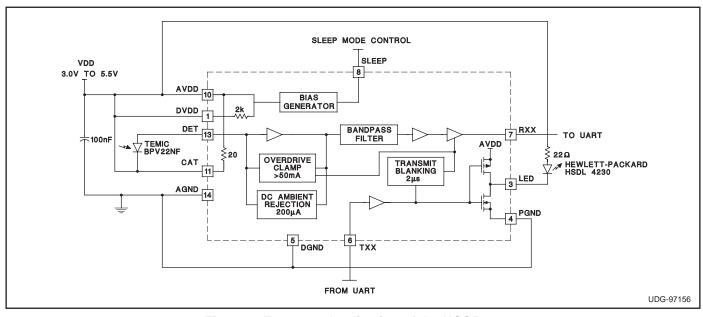


Figure 2. Economy Application of the UCC5342